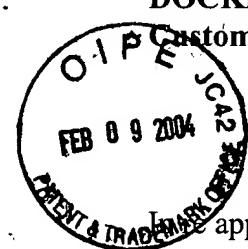


*Bmogl*

*\$ AF  
2812*



b1  
DOCKET NO. 94-C-096C3 (STMI01-94096)  
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: : KUEI-WU HUANG ET AL  
 Serial No. : 09/517,987  
 Filed : March 3, 2000  
 For : METHOD OF FORMING PLANARIZED STRUCTURES  
       IN AN INTEGRATED CIRCUIT  
 Group No. : 2812  
 Examiner : R.A. Booth

**MAIL STOP AF**

Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Sir:

**NOTICE OF APPEAL**

Applicant hereby appeals to the Board of Appeals from the decision dated November 6, 2003  
 of the Primary Examiner finally rejecting Claims 77-96.

A check in the amount of \$330.00 is enclosed in payment of the Notice of Appeal filing fee.  
 The Commissioner is hereby authorized to charge any additional fees connected with this  
 communication or credit any overpayment to Davis Munck Deposit Account No. 50-0208.

02/10/2004 DTESEM1 00000120 09517987

01 FC:1401

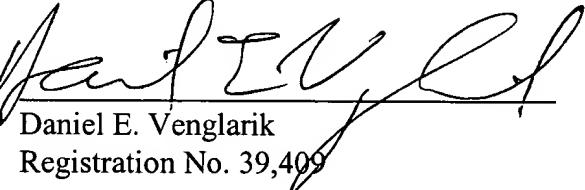
330.00 0P

ATTORNEY DOCKET No. 94-C-096C4 (STMI01-94096)  
U.S. SERIAL NO. 09/517,987  
PATENT

Respectfully submitted,

DAVIS MUNCK, P.C.

Date: 2-6-04

  
Daniel E. Venglarik  
Registration No. 39,409

P.O. Box 802432  
Dallas, Texas 75380  
Tel: (972) 628-3600  
Fax: (972) 628-3616  
E-mail: [dvenglarik@davismunck.com](mailto:dvenglarik@davismunck.com)